

# Termination, Chip

Model CC00GAV01

Legacy Model: KAC375-250AG

Frequency Range: DC to 3.0 GHz, Power: 150 Watts



#### **Features**

- High Power
- Thick Film Design
- Low VSWR
- Optimized for Heat Sink Mount

This high power device is designed to dissipate power in RF circuits when mounted to an appropriate heat sink. The terminations provide a low VSWR under maximum power conditions.

### **Technical Specifications**

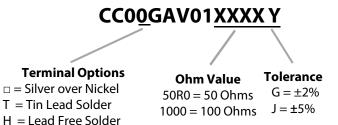
Parameter	Value
Frequency Range	DC to 3.0 GHz
Impedance	50 ±5% Standard
Power Handling*	150 Watts Avg. Derated Linearly to 0 Watts @ +150°C
VSWR	1.10:1 Max.
Temperature Range	-55°C to +150°C

#### Material

Feature	Material
Substrate	Aluminum Nitride
Resistor Material	Proprietary Thick Film
Terminal Finish	Silver– (See "How to Order" for tinning & other options)

<sup>\*</sup>Mounting surfaces shall not exceed 100°C. Max.

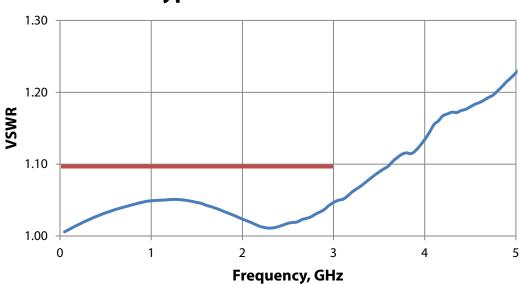
#### **How to Order**





Legacy Model: KAC375-250AG

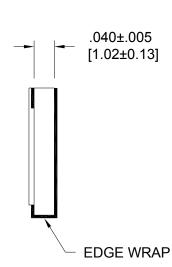
## **Typical Performance**



## **Physical Dimensions**

Model Number: KAC375-250AG-50R0J shown

.250 [6.35] 50Q .375 [9.53] .....



Dimensions are for substrate only and do not include terminal thickness or optional tinning thickness.

Tolerance: .XXX" - ±.010"

Note: Dimensions in Brackets [] are expressed in Millimeters and are for reference only

